

# EnerChip<sup>™</sup> CC CBC3150

# **EnerChip CC with Integrated Power Management**

### Features

- Power Manager with Charge Control
- Integrated 50µAh Thin Film Energy Storage
- Built-in Energy Storage Protection
- Temperature Compensated Charge Control
- Adjustable Switchover Voltage
- Charges Integrated EnerChip Over a Wide Supply Range
- Low Standby Power
- SMT Lead-Free Reflow Tolerant
- Thousands of Recharge Cycles
- Low Self-Discharge
- Eco-Friendly, RoHS Compliant

### **Applications**

- **Standby supply** for non-volatile SRAM, Real-time clocks, controllers, supply supervisors, and other system-critical components.
- Wireless sensors and RFID tags and other powered, low duty cycle applications.
- **Localized power source** to keep microcontrollers and other devices alert in standby mode.
- **Power bridging** to provide back-up power to system during exchange of main batteries.
- Consumer appliances that have real-time clocks; provides switchover power from main supply to integrated backup energy storage.
- Business and industrial systems such as: network routers, point-of-sale terminals, singleboard computers, test equipment, multi-function printers, industrial controllers, and utility meters.
- **Energy Harvesting** by coupling the EnerChip with energy transducers such as solar panels.



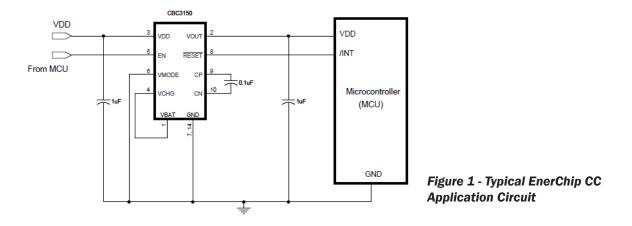
9 mm x 9 mm DFN SMT Package

The EnerChip CC is the world's first Intelligent Thin Film Energy Storage Device. It is an integrated solution that provides backup energy storage and power management for systems requiring power bridging and/or secondary power. A single EnerChip CC can charge up to 10 additional EnerChips connected in parallel.

During normal operation, the EnerChip CC charges itself with a controlled voltage using an internal charge pump that operates from 2.5V to 5.5V. An ENABLE pin allows for activation and deactivation of the charge pump using an external control line in order to minimize current consumption and take advantage of the fast recharge time of the EnerChip.

When the primary power supply dips below a userdefined threshold voltage, the EnerChip CC will signal this event and route the EnerChip voltage to Vout. The EnerChip CC also has energy storage protection circuitry to enable thousands of recharge cycles.

The CBC3150 is a 20-pin, 9 mm x 9 mm Dual Flat Nolead (DFN) package, available in tubes, trays, or tapeand-reel for use with automatic insertion equipment.



### **Electrical Properties**

EnerChip Backup Output voltage:	3.3V
Energy Capacity (typical):	50µAh
Recharge time to 80%:	20 minutes
Charge/Discharge cycles:	>5000 to 10% discharge
Physical Properties	
Physical Properties Package size:	9 mm x 9 mm
	9 mm x 9 mm -20°C to +70°C

### **Functional Block Diagram**

The EnerChip CC internal schematic is shown in Figure 2. The input voltage from the power supply (VDD) is applied to the charge pump, the control logic, and is compared to the user-set threshold as determined by the voltage on VMODE. VMODE is an analog input ranging from OV to VDD. The ENABLE pin is a digital input that turns off the charge pump when low. VOUT is either supplied from VDD or the integrated EnerChip energy storage device. RESET is a digital output that, when low, indicates VOUT is being sourced by the integrated EnerChip.

CFLY is the flying capacitor in the voltage doubler circuit. The value of CFLY can be changed if the output impedance of the EnerChip CC needs to be modified. The output impedance is dictated by 1/fC, where *f* is the frequency of oscillation (typically 100kHz) and *C* is the capacitor value (typically 0.1µF). GND is system ground.

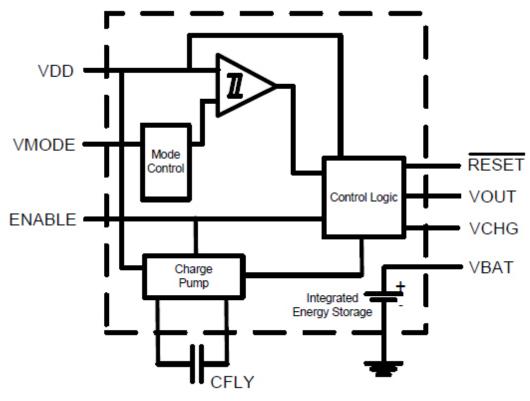
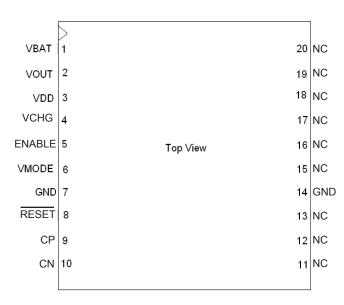


Figure 2: EnerChip CC CBC3150 Internal Block Diagram

Pin Number	Label	Description
1	VBAT	Positive EnerChip Terminal - Tie to Pin 4
2	Vout	System Voltage
3	Vdd	Input Voltage
4	Vснg	EnerChip Charge Voltage - Tie to Pin 1 and/or Optional EnerChip(s)
5	ENABLE	Charge Pump Enable
6	VMODE	Mode Select for Backup Switchover Threshold
7	GND	System Ground
8	RESET	Reset Signal (Active Low)
9	Ср	Flying Capacitor Positive
10	CN	Flying Capacitor Negative
11	NC	No Connection
12	NC	No Connection
13	NC	No Connection
14	GND	System Ground
15	NC	No Connection
16	NC	No Connection
17	NC	No Connection
18	NC	No Connection
19	NC	No Connection
20	NC	No Connection

# **Device Input/Ouput Descriptions**





## Absolute Maximum Ratings

PARAMETER	CONDITION	MIN	TYPICAL	MAX	UNITS
VDD with respect to GND	25°C	GND - 0.3	-	6.0	V
ENABLE and VMODE Input Voltage	25°C	GND - 0.3	-	VDD+0.3	V
VBAT <sup>(1)</sup>	25°C	3.0	-	4.3	V
VCHG <sup>(1)</sup>	25°C	3.0	-	4.3	V
Vout	25°C	GND-0.3	-	6.0	V
RESET Output Voltage	25°C	GND - 0.3	-	Vout+0.3	V
CP, Flying Capacitor Voltage	25°C	GND - 0.3	-	6.0	V
CN	25°C	GND - 0.3	-	VDD+0.3	V

<sup>(1)</sup> No external connections to these pins are allowed, except parallel EnerChips.

### **Operating Characteristics**

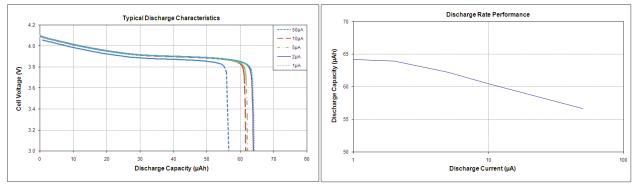
PARAMETER		CONDITION	MIN	TYPICAL	MAX	UNITS
Output Voltage Vout		VDD > VTH	-	Vdd	-	V
Output Voltage Vout (k	backup mode)	VDD < VTH	2.2	3.3	3.6	V
EnerChip Pulse Discha	arge Current	-	Variable -	see App. No	ote 1025	-
Self-Discharge (5 yr av	verage)	Non-recoverable	-	2.5	-	% per year
		Recoverable	-	1.5 (1)	-	% per year
Operating Temperatur	e	-	-20	25	+70	°C
Storage Temperature		-	-40	-	+125 (2)	°C
Cell Resistance (25°C	;)	Charge cycle 2	-	0.75	2	ĿО
		Charge cycle 1000	-	4.2	7	kΩ
Recharge Cycles	25°C	10% depth-of-discharge	5000	-	-	cycles
(to 80% of rated ca-		50% depth-of discharge	1000	-	-	cycles
pacity; 4.1 V charge voltage)	40°C	10% depth-of-discharge	2500	-	-	cycles
voltage)		50% depth-of-discharge	500	-	-	cycles
Recharge Time (to 80% of rated ca- pacity; 4.1V charge voltage; 25°C)		Charge cycle 2	-	20	35	minutoo
		Charge cycle 1000	-	60	95	minutes
Capacity		100µA discharge; 25°C	50	-	-	μAh

<sup>(1)</sup> *First month recoverable self-discharge is 4% average.* 

<sup>(2)</sup> Storage temperature is for uncharged EnerChip CC device.

Note: All specifications contained within this document are subject to change without notice.

### **EnerChip Discharge Characteristics**



### **POWER SUPPLY CURRENT CHARACTERISTICS** Ta = -20°C to +70°C

CHARACTERISTIC	SYMBOL	CONDITION		MIN	MAX	UNITS
		ENABLE=GND	VDD=3.3V	-	3.5	μA
Quiescent Current	lq	ENABLE-GIND	VDD=5.5V	-	6.0	μA
Quiescent ourient	īQ	ENABLE=VDD	VDD=3.3V	-	35	μA
		ENABLE-VDD	VDD=5.5V	-	38	μA
	IQBATOFF	VBAT < VBATCO, Vout=0		-	0.5	nA
EnerChip Cutoff Current	IQBATON	VBAT > VBATCO, ENABLE=VDD, Id	out <b>=0</b>	-	42	nA

## INTERFACE LOGIC SIGNAL CHARACTERISTICS

### VDD = 2.5V to 5.5V, Ta = -20°C to +70°C

CHARACTERISTIC	SYMBOL	CONDITION	MIN	MAX	UNITS
High Level Input Voltage	Vih	-	Vdd - 0.5	-	Volts
Low Level Input Voltage	VIL	-	-	0.5	Volts
High Level Output Voltage	Vон	V <sub>DD</sub> >Vтн (see Figures 4 and 5) IL=10µA	Vdd - 0.04V <sup>(1)</sup>	-	Volts
Low Level Output Voltage	Vol	IL = -100μA	-	0.3	Volts
Logic Input Leakage Current	lin	0 <vin<vdd< td=""><td>-1.0</td><td>+1.0</td><td>nA</td></vin<vdd<>	-1.0	+1.0	nA

(1)  $\overline{RESET}$  tracks VDD;  $\overline{RESET} = VDD - (IOUT \times ROUT)$ .

# **RESET SIGNAL AC/DC CHARACTERISTICS**

### VDD = 2.5V to 5.5V, Ta = -20°C to +70°C

CHARACTERISTIC	SYMBOL	CONDITION	MIN	MAX	UNITS
VDD Rising to RESET Rising	treseth	Vpd rising from 2.8V TO 3.1V in <10µs	60	200	ms
VDD Falling to RESET Falling	<b>TRESETL</b>	Vod falling from 3.1V to 2.8V in <100ns	0.5	2	μs
Mode 1 TRIP V Vdd Rising	Vreset	V <sub>MODE</sub> = GND	2.80	3.20	V
Mode 2 TRIP V <sup>(2)</sup> VDD Rising	Vreset	VMODE = VDD/2	2.25	2.60	V
RESET Hysteresis		Vmode=Vdd	60	100	
Voltage (3)	VHYST	VMODE=GND	45	75	mV
(VDD to RESET)		VMODE = VDD/2	30	50	

(2) User-selectable trip voltage can be set by placing a resistor divider from the VMODE pin to GND. Refer to Figure 8.

<sup>(3)</sup> The hysteresis is a function of trip level in Mode 2. Refer to Figure 9.

## CHARGE PUMP CHARACTERISTICS VDD = 2.5V to 5.5V, Ta = -20°C to +70°C

CHARACTERISTIC	SYMBOL	CONDITION	MIN	MAX	UNITS
ENABLE=VDD to Charge Pump Active	tcpon	ENABLE to 3rd charge pump pulse, VDD=3.3V	60	80	μs
ENABLE Falling to Charge Pump Inactive	<b>t</b> CPOFF	-	0	1	μs
Charge Pump Frequency	fcp		-	120	KHz (1)
Charge Pump Resistance	Rcp	Delta VBAT, for IBAT charging current of 1µA to 100µA CFLY=0.1µF, CBAT=1.0µF	150	300	Ω
Vchg Output Voltage	Vcp	CFLY=0.1μF, CBAT=1.0μF, Ιουτ=1μΑ, Temp=+25°C	4.075	4.125	V
Vснg Temp. Coefficient	Тсср	Ιουτ=1μΑ, Temp=+25°C	-2.0	-2.4	mV/°C
Charge Pump Current Drive	ICP	I <sub>BAT</sub> =1mA C <sub>FLY</sub> =0.1μF, C <sub>BAT</sub> =1.0μF	1.0	-	mA
Charge Pump on Voltage	VENABLE	ENABLE=VDD	2.5	-	V

<sup>(1)</sup>  $f_{CP} = 1/t_{CPPER}$ 

# ADDITIONAL CHARACTERISTICS

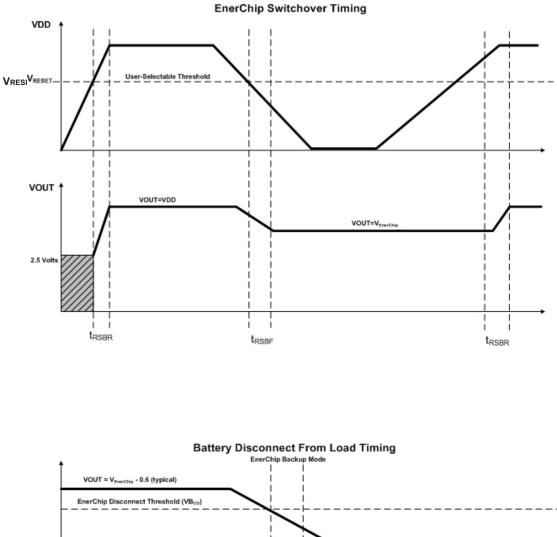
### Ta = -20°C to +70°C

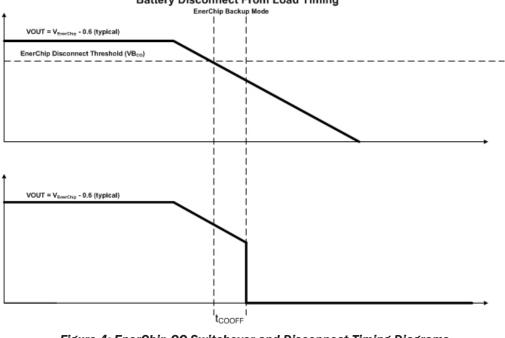
CHARACTERISTIC	SYMBOL	CONDITION	CONDITION LIMITS		UNITS
			MIN	MAX	
VBAT Cutoff Threshold	VBATCO	Ιουτ=1μΑ	2.75	3.25	V
Cutoff Temp. Coefficient	Тссо	-	+1	+2	mV/°C
VBAT Cutoff Delay Time	tcooff	VBAT from 40mV above to 20mV below VBATCO IOUT=1µA	40	-	ms
Vout Dead Time, Vod Rising <sup>(2)</sup>	trsbr	Iout=1mA VBAT=4.1V	0.2	2.0	μs
Vout Dead Time, Vdd Falling <sup>(2)</sup>	<b>t</b> RSBF	VBAT=4.1V	0.2	2.0	μs
Bypass Resistance	Rout	-	-	2.5	Ω

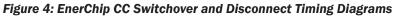
<sup>(2)</sup> Dead time is the time period when the Vout pin is floating. Size the holding capacitor accordingly.

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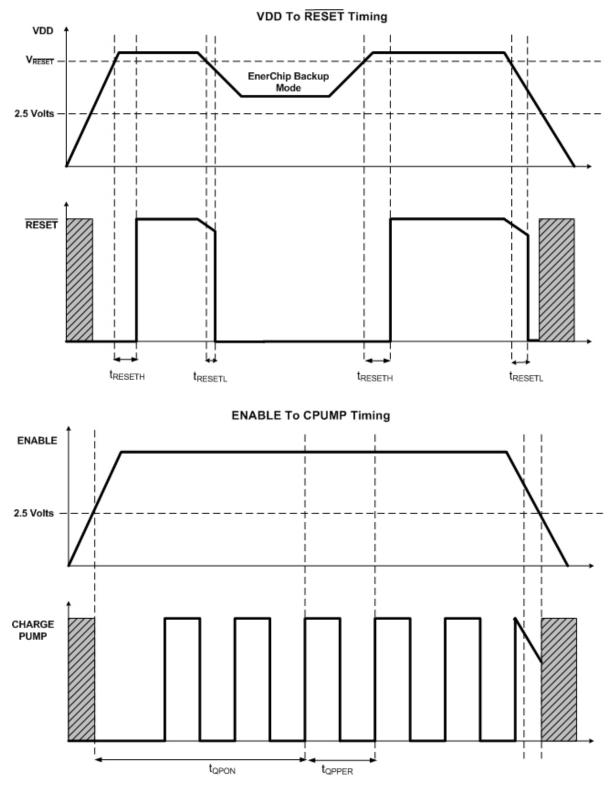
Important timing diagrams for the EnerChip CC relationship between EnerChip Switchover Timing and EnerChip Disconnect from Load Timing are shown in Figure 4.







Timing diagrams for the EnerChip CC relationship between  $V_{DD}$  to RESET and ENABLE high to charge pump becoming active are shown in Figure 5.





### **EnerChip CC Detailed Description**

The EnerChip CC uses a charge pump to generate the supply voltage for charging the integrated energy storage device. An internal FET switch with low RDSoN is used to route VDD to VOUT during normal operation when main power is above the switchover threshold voltage. When VDD is below the switchover threshold voltage, the FET switch is shut off and Vout is supplied by the EnerChip. An interrupt signal is asserted low prior to the switchover.

### **Operating Modes**

The EnerChip CC can be operated from various power supplies such as a primary source or a non-rechargeable battery. With the ENABLE pin asserted high, the charge pump is active and charges the integrated EnerChip. The EnerChip CC will be 80% charged within 20 minutes. Due to the rapid recharge it is recommended that, once the EnerChip CC is fully charged, the user de-assert the ENABLE pin (i.e., force low) to reduce power consumption. A signal generated from the MCU could be used to enable and disable the EnerChip CC.

When controlling the ENABLE pin by way of an external controller - as opposed to fixing the ENABLE line to VDD - ensure that the ENABLE pin is forced low by the controller anytime the RESET line is low, which occurs when the switchover threshold voltage is reached and the device is placed in backup mode. Although the internal charge pump is designed to operate below the threshold switchover level when the ENABLE line is active, it is recommended that the ENABLE pin be forced low whenever RESET is low to ensure no parasitic loads are placed on the EnerChip while in this mode. If ENABLE is high or floating while VDD is in an indeterminate state, bias currents within the EnerChip CC could flow, placing a parasitic load on the EnerChip that could dramatically reduce the effective backup operating time.

The EnerChip CC supports 2 operational modes as shown in Figures 6 and 7.

### Mode 1 Operation

For use in 3.3 volt systems. The VMODE pin should be tied directly to GND, as shown in Figure 6. This will set the switchover threshold at approximately 3.0 volts.

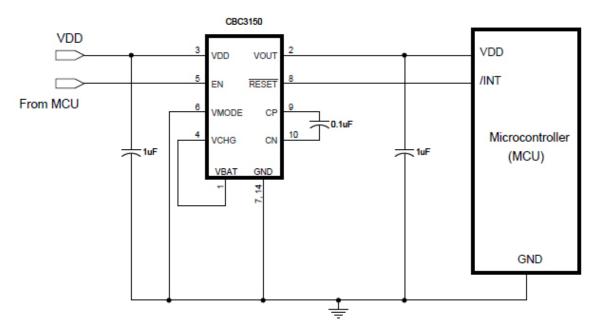
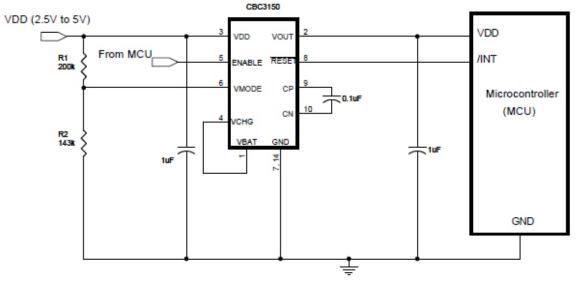
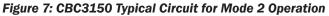


Figure 6: CBC3150 Typical Circuit for Mode 1 Operation

### Mode 2 Operation

Figure 7 shows the circuitry for user-selectable switchover threshold to a value between 2.5 and 5.0 volts. Use Figure 8 to determine the value of R1. To determine the amount of hysteresis from the EnerChip switchover threshold, use Figure 9.





EnerChip charging and backup power switchover threshold for 2.5 to 5.5 volt operation is selected by changing the value of R2 (see Figure 7). To determine the backup switchover point, set the value of R1 to  $200k\Omega$  and choose the value of R2 according to Figure 8. For example, to set a 3.0V trip point: If R1=200 k $\Omega$  then R2 = R1 x 0.72 = 144k $\Omega$ . Figure 7 shows a Mode 2 circuit with standard value resistors of  $200k\Omega$  and  $143k\Omega$ .

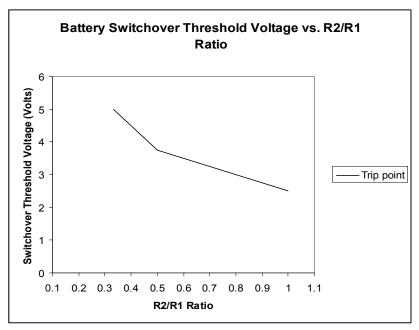
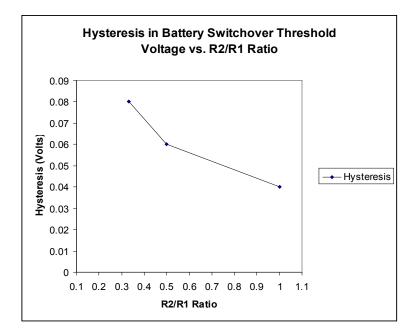


Figure 8: Mode 2 Resistor Selection Graph

To determine the backup switchover hysteresis for Mode 2 operation, use Figure 9.





### **Real-Time Clock Application Circuit**

The EnerChip CC as depicted in Figure 10 is a typical application circuit in a 3.3 volt system where backup and power switchover circuitry for a real-time clock device is provided.

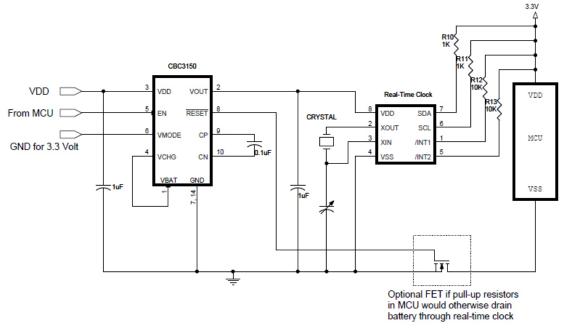


Figure 10: EnerChip CC Providing Real-Time Clock Backup Power

### Adding Power and Energy Capacity with Parallel EnerChips

In some applications, additional energy storage capacity might be needed. The schematic in Figure 11 shows how multiple EnerChips can be supported in parallel by a single EnerChip CC CBC3150. Note that CFLY should be increased by  $0.1\mu$ F for every additional EnerChip.

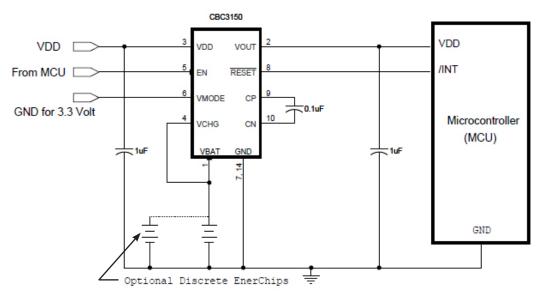


Figure 11: EnerChip CC Providing Power Management for Multiple EnerChips

### EnerChip CC CBC3150 PCB Layout Guidelines - Important Notice!

There are several PCB layout considerations that must be taken into account when using the CBC3150:

- 1. All capacitors should be placed as close as possible to the EnerChip CC. The flying capacitor connections must be as short as possible and routed on the same layer the EnerChip CC is placed.
- 2. Power connections should be routed on the layer the EnerChip CC is placed.
- 3. A ground (GND) plane in the PCB should be used for optimal performance of the EnerChip CC.
- 4. Very low parasitic leakage currents from the VBAT pin to power, signal, and ground connections, can result in unexpected drain of charge from the integrated power source. Maintain sufficient spacing of traces and vias from the VBAT pin and any traces connected to the VBAT pin in order to eliminate parasitic leakage currents that can arise from solder flux or contaminants on the PCB.
- 5. Pin 1 VBAT and Pin 4 VCHG must be tied together for proper operation.
- 6. There should be no traces, vias or connections under the CBC3150 exposed die pad.
- 7. When placing a silk screen on the PCB around the perimeter of the package, place the silk screen outside of the package and all metal pads. Failure to observe this precaution can result in package cracking during solder reflow due to the silk screen material interfering with the solder solidification process during cooling.
- 8. See Figure 12 for location and dimensions of metal pad placement on the PCB.

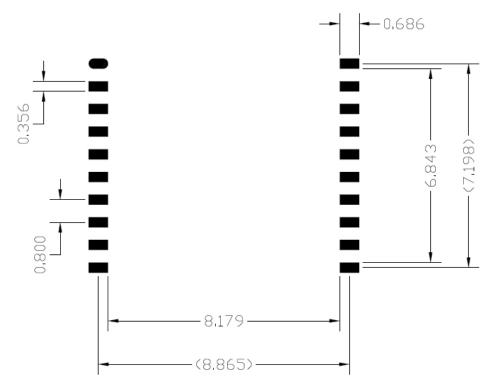
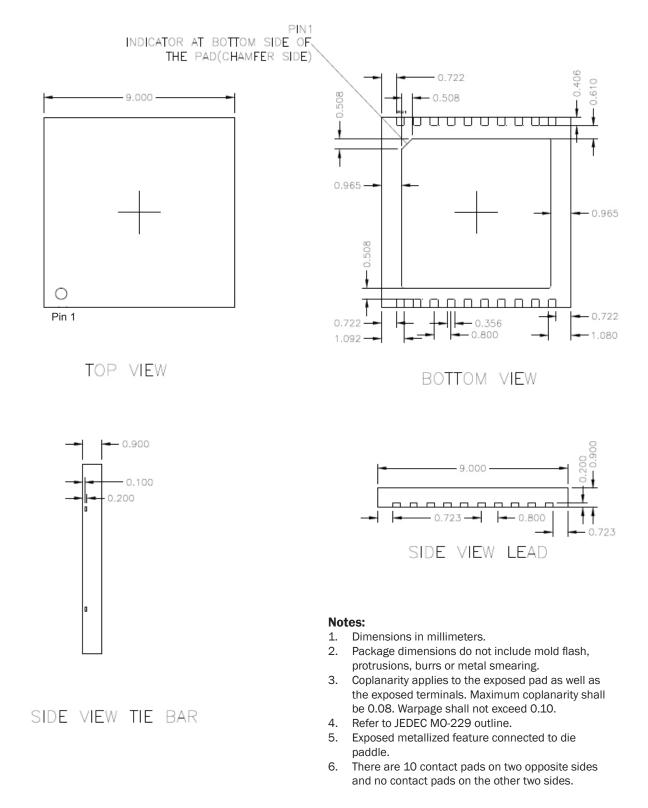


Figure 12: Recommended PCB Layout for the CBC3150-D9C Package (Dimensions in mm)



### CBC3150 9mm x 9mm DFN Package Drawing and Dimensions

### **Energy Harvesting with the EnerChip CC**

The EnerChip CC can be configured to collect energy from transducers such as low power photovoltaic (PV) cells and use that harvested energy to charge the integrated EnerChip and deliver self-sustaining power to components such as microcontrollers, sensors, and radios in wireless systems. The schematic of Figure 13 illustrates the feedback connection made from RESET to EN to implement the energy harvesting function with the CBC3150. In order to make most efficient use of the power available from the transducer (for example, a PV cell), it is necessary to know the electrical characteristics including voltage and peak power point of the transducer being used. For assistance in designing your system to effectively harvest energy from a power transducer in a specific environment, contact Cymbet Applications Engineering.

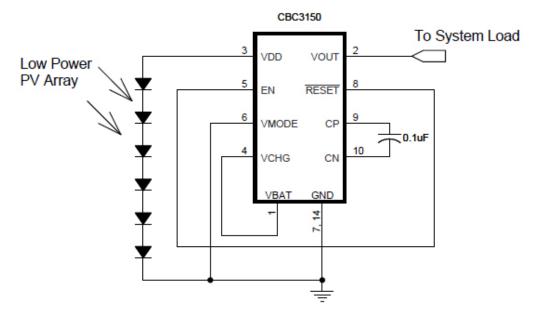


Figure 13: Implementing Energy Harvesting with the EnerChip CC

### **Ordering Information**

EnerChip CC Part Number	Description	Notes
CBC3150-D9C	EnerChip CC 50µAh in 20-pin D9 DFN Package	Shipped in Tube
CBC3150-D9C-TR1 CBC3150-D9C-TR5	EnerChip CC 50µAh in 20-pin D9 DFN Package	Tape-and-Reel - 1000 pcs (TR1) or 5000 pcs (TR5) per reel
CBC3150-D9C-WP	EnerChip CC 50µAh in 20-pin D9 DFN Package	Waffle Pack

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